



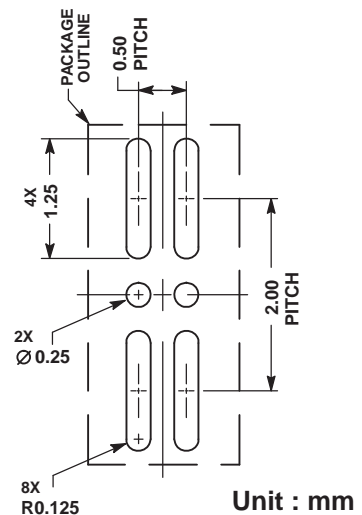
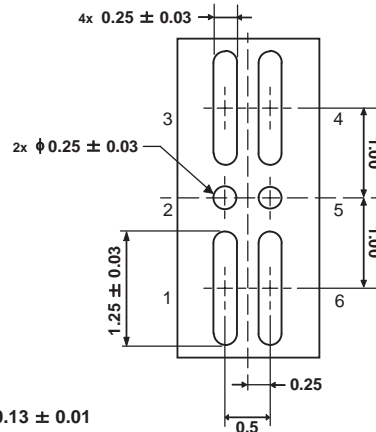
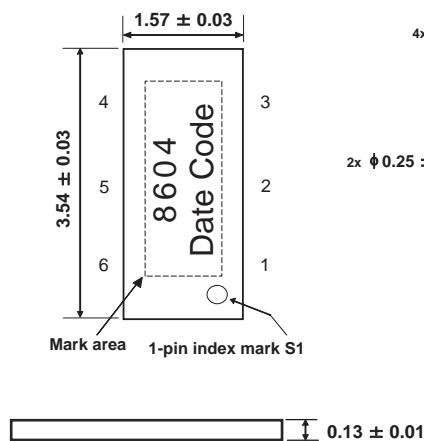
Ver 3.0

PRODUCT SUMMARY

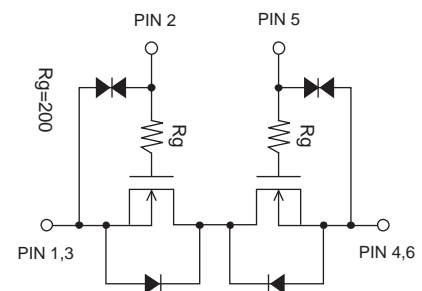
VSSS	IS	RSS(ON) (mΩ) Typ
12V	18A	2.5 @ VGS=4.5V
		2.6 @ VGS=4.0V
		2.8 @ VGS=3.8V
		3.3 @ VGS=3.1V
		4.0 @ VGS=2.5V

- Super high dense cell design for low $R_{DS(ON)}$.
- Rugged and reliable.
- Wafer level CSP.
- ESD Protected.

LAND PATTERN (REFERENCE)



Symbol	Parameter	Limit	Units
V _{SSS}	Source-Source Voltage	12	V
V _{GSS}	Gate-Source Voltage	±8	V
I _S	Source Current-Continuous ^a	18	A
I _{SP}	-Pulsed ^b	100	A
P _T	Total Power Dissipation ^a	1.7	W
T _J , T _{STG}	Operating Junction and Storage Temperature Range	-55 to 150	°C

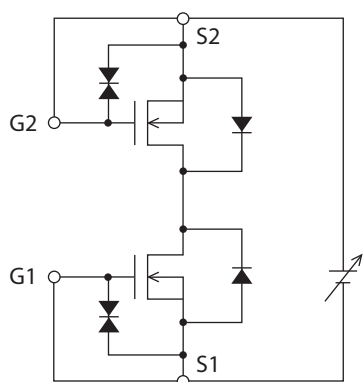


PIN 1 : Source 1
PIN 2 : Gate 1
PIN 3 : Source 1
PIN 4 : Source 2
PIN 5: Gate 2
PIN 6 : Source 2

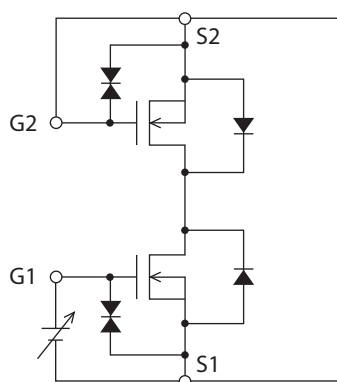
ELECTRICAL CHARACTERISTICS (T_A=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV _{SSS}	Source-Source Breakdown Voltage	V _{GS} =0V , I _S =1mA	12			V
I _{SSS}	Zero Gate Voltage Source Current	V _{SS} =10V , V _{GS} =0V			1	uA
I _{GSS}	Gate-Body Leakage Current	V _{GS} = ±8V , V _{SS} =0V			±10	uA
		V _{GS} = ±5V , V _{SS} =0V			±1	uA
ON CHARACTERISTICS						
V _{GS(th)}	Gate Threshold Voltage	V _{SS} =V _{GS} , I _S =1mA	0.5		1.3	V
R _{SS(ON)}	Source-Source On-State Resistance	V _{GS} =4.5V , I _S =5.0A	1.8	2.5	3.2	m ohm
		V _{GS} =4.0V , I _S =5.0A	1.9	2.6	3.3	m ohm
		V _{GS} =3.8V , I _S =5.0A	2.0	2.8	3.4	m ohm
		V _{GS} =3.1V , I _S =5.0A	2.1	3.2	5.0	m ohm
		V _{GS} =2.5V , I _S =5.0A	2.7	4.0	7.0	m ohm
g _{FS}	Forward Transconductance	V _{SS} =5V , I _S =3A		19		S
SWITCHING CHARACTERISTICS ^c						
t _{D(ON)}	Turn-On Delay Time	V _{DD} =6V I _S =3A V _{GS} =4.5V R _{GEN} =6 ohm		80		ns
t _r	Rise Time			570		ns
t _{D(OFF)}	Turn-Off Delay Time			38000		ns
t _f	Fall Time			17700		ns
Q _g	Total Gate Charge	V _{DD} =6V,I _S =18A, V _{GS} =4.5V		100		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
V _{FSS}	Diode Forward Voltage	V _{GS} =0V,I _S =3A		0.75	1.2	V
Note						
a.Mounted on FR4 board of 25.4mm x 25.4mm x 1.0mm.						
b.Pulse Test:Pulse Width < 10us, Duty Cycle < 1%.						
c.Guaranteed by design, not subject to production testing.						

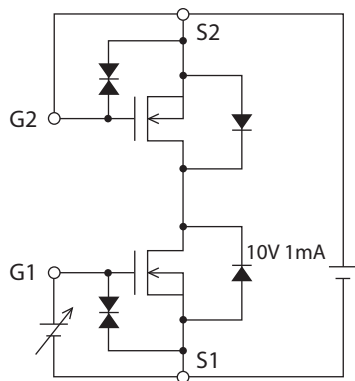
V_{SSS} / I_{SSS}



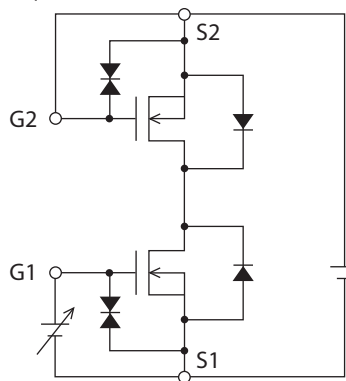
$I_{GSS} (+) / (-)$



$V_{GS} (off)$

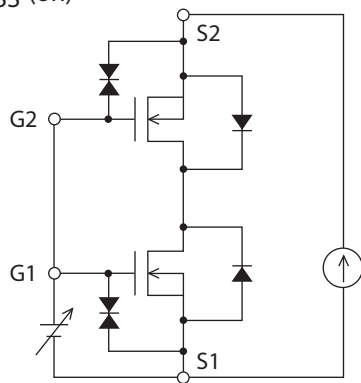


$|y_{fs}|$

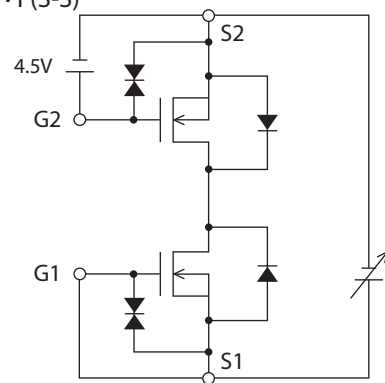


* Note: Connect the measurement terminal reversely if you want to measure the FET2 side.

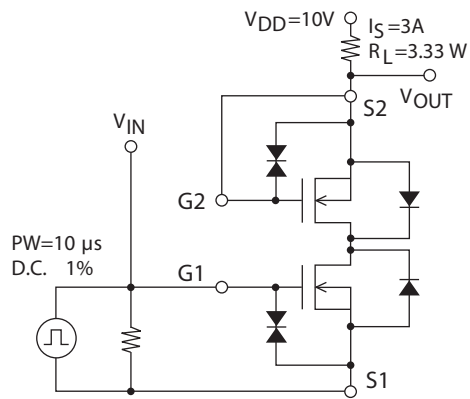
$R_{SS}(\text{on})$



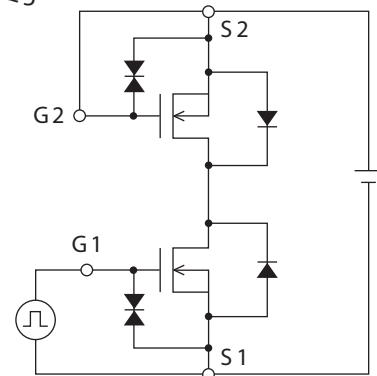
$V_F(S-S)$



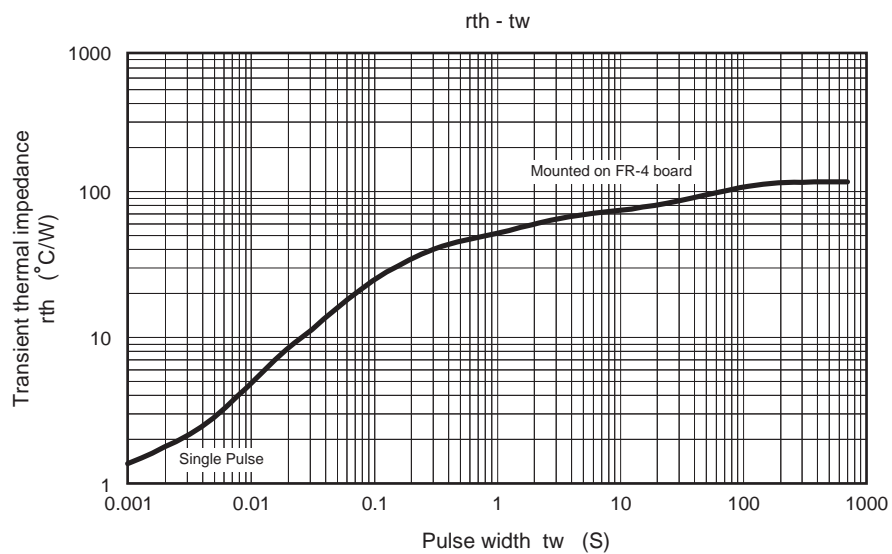
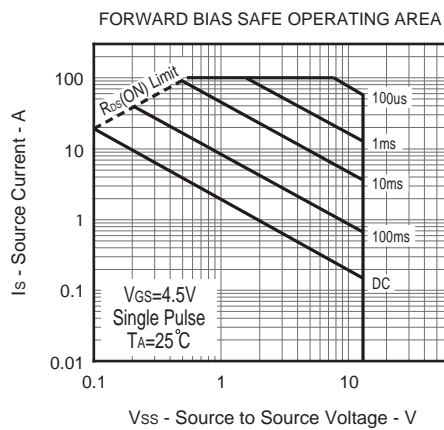
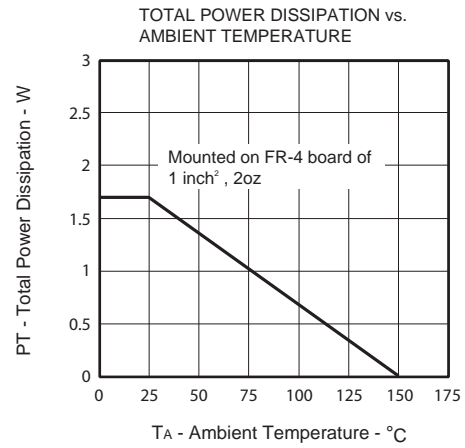
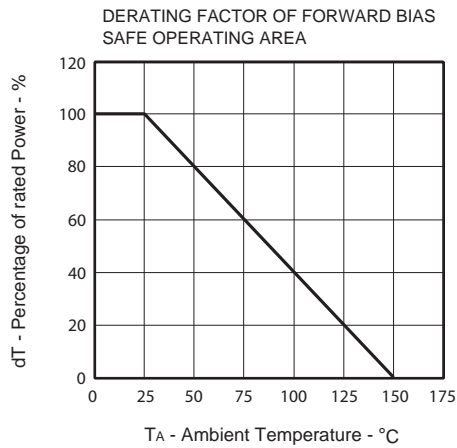
$t_d(\text{on}), t_r, t_d(\text{off}), t_f$

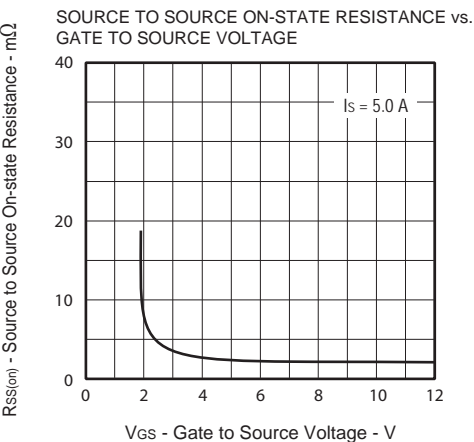
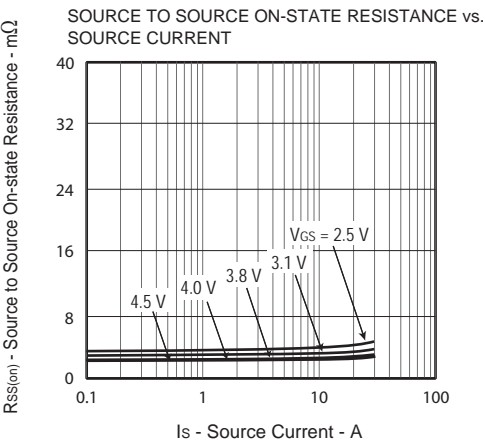
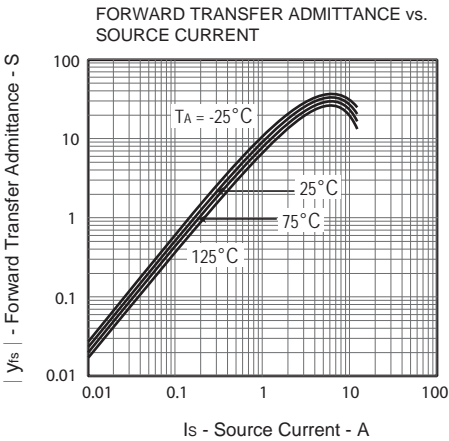
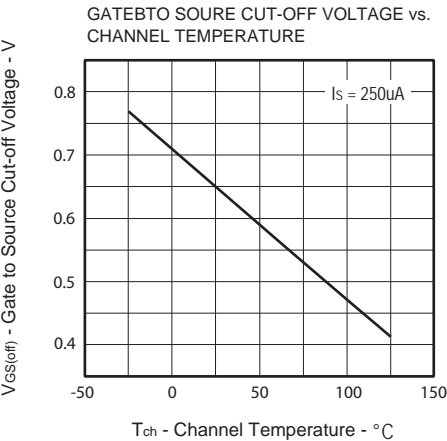
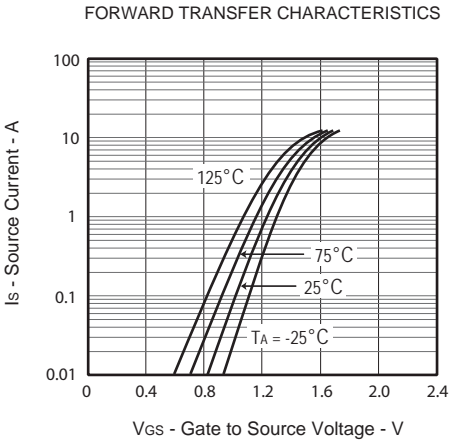
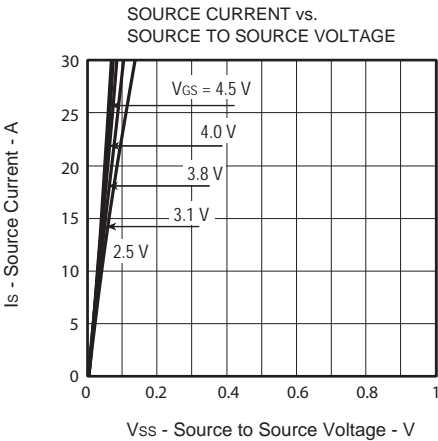


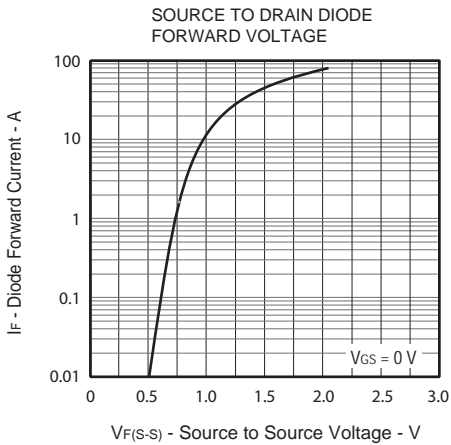
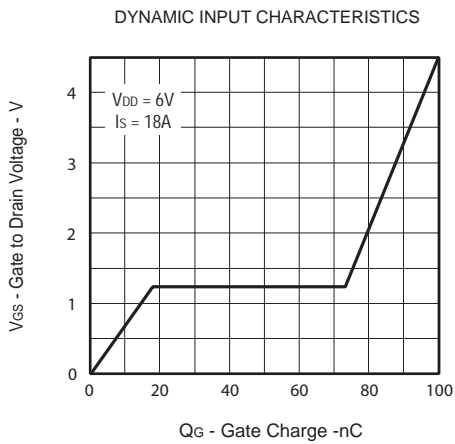
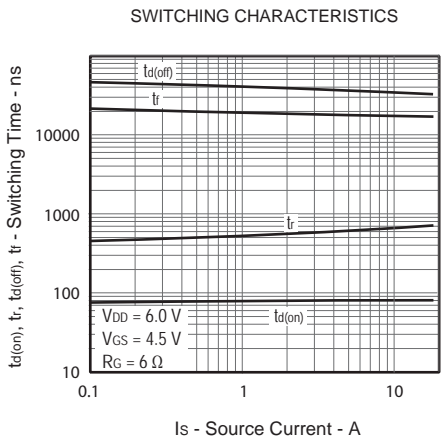
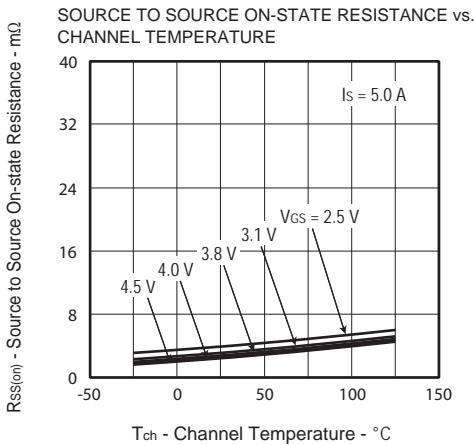
Q_g



* Note: Connect the measurement terminal reversely if you want to measure the FET2 side.







TOP MARKING DEFINITION

WLCSP

